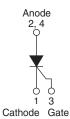


Thyristor Surface Mount, Phase Control SCR, 16 A





PRODUCT SUMMARY								
Package	TO-263AB (D ² PAK)							
Diode variation	Single SCR							
I _{T(AV)}	16 A							
V _{DRM} /V _{RRM}	1600 V							
V _{TM}	1.25 V							
I _{GT}	45 mA							
TJ	-40 to 125 °C							

FEATURES

- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Designed and qualified according JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Input rectification (soft start)
- Vishay input diodes, switches and output rectifiers which are available in identical package outlines

DESCRIPTION

The VS-25TTS16SPbF of silicon controlled rectifiers is specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS								
APPLICATIONS	SINGLE-PHASE BRIDGE	THREE-PHASE BRIDGE	UNITS					
NEMA FR-4 or G10 glass fabric-based epoxy with 4 oz. (140 μm) copper	3.5	5.5						
Aluminum IMS, R _{thCA} = 15 °C/W	8.5	13.5	A					
Aluminum IMS with heatsink, R _{thCA} = 5 °C/W	16.5	25.0						

Note

• $T_A = 55 \,^{\circ}\text{C}$, $T_J = 125 \,^{\circ}\text{C}$, footprint 300 mm²

MAJOR RATINGS AND CHARACTERISTICS								
PARAMETER	TEST CONDITIONS	VALUES	UNITS					
I _{T(AV)}	Sinusoidal waveform	16	А					
I _{RMS}		25	^					
V _{RRM} /V _{DRM}		1600	V					
I _{TSM}		350	Α					
V _T	16 A, T _J = 25 °C	1.25	V					
dV/dt		500	V/µs					
dl/dt		150	A/µs					
TJ		-40 to +125	°C					

VOLTAGE RATINGS			
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} , AT 125 °C mA
VS-25TTS16SPbF	1600	1600	10



ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEO	T CONDITIONS	VAL	UES	UNITS		
PARAMETER	STINIBUL	SYMBOL TEST CONDITIONS		TYP.	MAX.	UNITS		
Maximum average on-state current	I _{T(AV)}	T _C = 93 °C, 180° co	onduction half sine wave	1	6			
Maximum RMS on-state current	I _{RMS}			2	5	Α		
Maximum peak, one-cycle,	L	10 ms sine pulse, r	ated V _{RRM} applied	30	00	_ ^		
non-repetitive surge current	I _{TSM}	10 ms sine pulse, r	no voltage reapplied	3	50			
Maximum I ² t for fusing	l ² t	10 ms sine pulse, r	ated V _{RRM} applied	450		A ² s		
waximum i-t for fushing	1-1	10 ms sine pulse, no voltage reapplied			30			
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to 10 ms	t = 0.1 ms to 10 ms, no voltage reapplied			A²√s		
Maximum on-state voltage drop	V_{TM}	16 A, T _J = 25 °C	16 A, T _J = 25 °C			V		
On-state slope resistance	r _t	T. _. = 125 °C		12.0		mΩ		
Threshold voltage	V _{T(TO)}	1J = 125 C		1	.0	V		
Maximum reverse and direct leakage current	1 /1	T _J = 25 °C	V - Batad V A/	0	.5			
Maximum reverse and direct leakage current	I _{RM} /I _{DM}	T _J = 125 °C	V _R = Rated V _{RRM} /V _{DRM}	10		1		
Holding current	I _H	Anode supply = 6 V, resistive load, initial $I_T = 1$ A, $T_J = 25$ °C		-	150	mA		
Maximum latching current	ΙL	Anode supply = 6 V, resistive load, T _J = 25 °C			I _L Anode supply = 6 V, resistive load, T _J = 25 °C 200		00	
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear}$	r to 80 %, $V_{DRM} = R_g - k = Open$	oen 500		V/µs		
Maximum rate of rise of turned-on current	dl/dt			150		A/µs		

TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum peak gate power	P _{GM}		8.0	W	
Maximum average gate power	P _{G(AV)}		2.0	VV	
Maximum peak positive gate current	+ I _{GM}		1.5	Α	
Maximum peak negative gate voltage	- V _{GM}		10	V	
		Anode supply = 6 V, resistive load, T _J = - 10 °C	60	1	
Maximum required DC gate current to trigger	I _{GT}	Anode supply = 6 V, resistive load, $T_J = 25 ^{\circ}\text{C}$	45	mA	
		Anode supply = 6 V, resistive load, T_J = 125 $^{\circ}$ C	20		
		Anode supply = 6 V, resistive load, T _J = - 10 °C	2.5		
Maximum required DC gate voltage to trigger	V_{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	2.0	V	
		Anode supply = 6 V, resistive load, T _J = 125 °C	1.0	V	
Maximum DC gate voltage not to trigger	V_{GD}	T 105 °C V Detect value	0.25		
Maximum DC gate current not to trigger	I _{GD}	T _J = 125 °C, V _{DRM} = Rated value	2.0	mA	

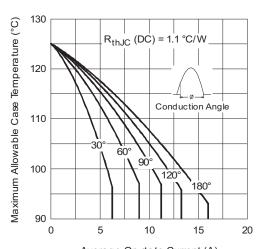
SWITCHING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Typical turn-on time	t _{gt}	T _J = 25 °C	0.9					
Typical reverse recovery time	t _{rr}	T - 105 °C	4	μs				
Typical turn-off time	t _q	T _J = 125 °C	110	,				



THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS					
Maximum junction and storage temperature range	T _J , T _{Stg}		-40 to +125	°C			
Soldering temperature	T _S	For 10 s (1.6 mm from case)	260				
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	1.1	°C/W			
Typical thermal resistance, junction to ambient (PCB mount)	R _{thJA} ⁽¹⁾		40	C/VV			
Approximate weight			2	g			
Approximate weight			0.07	OZ.			
Marking device		Case style D ² PAK (SMD-220)	25TT	S16S			

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm] copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994



Average On-state Current (A) Fig. 1 - Current Rating Characteristics

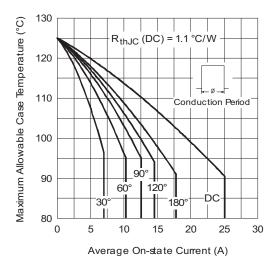


Fig. 2 - Current Rating Characteristics

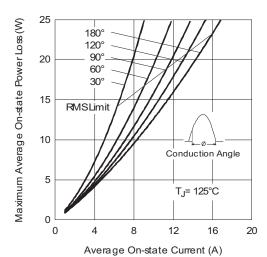


Fig. 3 - On-State Power Loss Characteristics

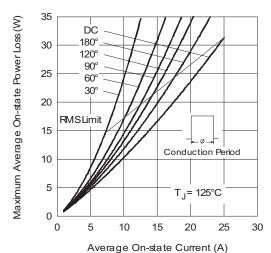


Fig. 4 - On-State Power Loss Characteristics

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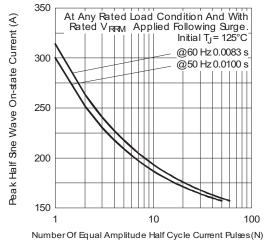


Fig. 5 - Maximum Non-Repetitive Surge Current

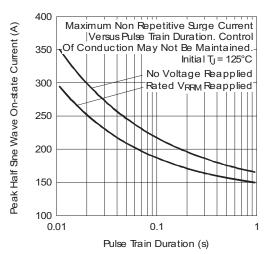


Fig. 6 - Maximum Non-Repetitive Surge Current

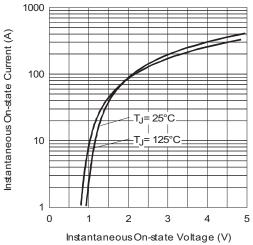
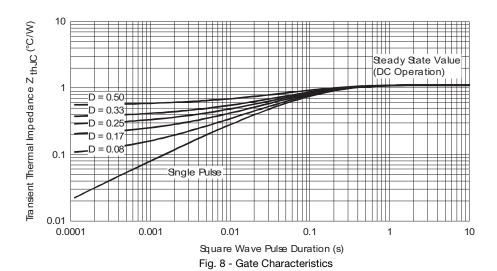


Fig. 7 - On-State Voltage Drop Characteristics



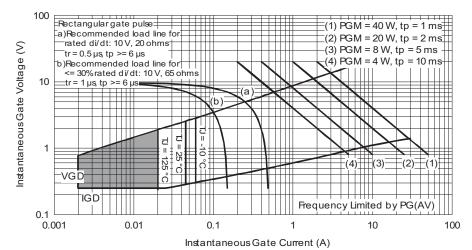


Fig. 9 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

Device code	VS-	25	Т	Т	S	16	S	TRL	PbF
	(1)	(2)	(3)	4)	(5)	6)	7)	8)	9)
	1 .	· Visl	nay Sen	nicondu	ctors pro	oduct			
	2 -	- Current rating (25 = 25 A)							
	3		Circuit configuration:						
	4	Pac	single t kage: TO-220	•					
	5	Тур	e of silic		ory root	ifior			
	6			ing: volta	•		= V _{RRN}	ı ——	16 = 1
	7	· S=	$S = TO-220 D^2PAK (SMD-220) version$						
	8 -	• TF		be e and re be and r	`		,		
	9 -	PbF	= lead	(Pb)-fre	е				

ORDERING INFORMATION (Example)									
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-25TTS16SPbF	50	1000	Antistatic plastic tubes						
VS-25TTS16STRRPbF	800	800	13" diameter reel						
VS-25TTS16STRLPbF	800	800	13" diameter reel						

LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?95046					
Part marking information	www.vishay.com/doc?95054					
Packaging information	www.vishay.com/doc?95032					



D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOIES	NOTES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54 BSC 0.100 BSC				
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	L3 0.25 BSC 0.010 BSC				
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



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